

Field Stop Trench IGBT

650 V, 75 A

75 A, 650 V
 $V_{CEsat} = 1.45 V$

FGHL75T65MQDTL4

Field stop 4th generation mid speed IGBT technology Full current rated copack Diode technology.

Features

- Maximum Junction Temperature: $T_J = 175^\circ C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.45 V$ (Typ.) @ $I_C = 75 A$
- 100% of the Parts are Tested for I_{LM} (Note 2)
- Smooth and Optimized Switching
- Tight Parameter Distribution
- RoHS Compliant

Typical Applications

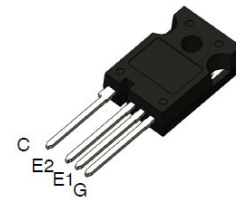
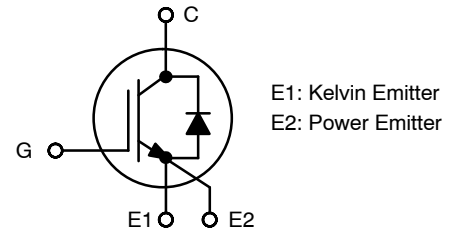
- Solar Inverter
- UPS, ESS
- PFC, Converters

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector to Emitter Voltage	V_{CES}	650	V
Gate to Emitter Voltage Transient Gate to Emitter Voltage	V_{GES}	± 20 ± 30	V
Collector Current (Note 1) @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	I_C	80 75	A
Pulsed Collector Current (Note 2)	I_{LM}	300	A
Pulsed Collector Current (Note 3)	I_{CM}	300	A
Diode Forward Current (Note 1) @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	I_F	80 75	A
Pulsed Diode Maximum Forward Current	I_{FM}	300	A
Maximum Power Dissipation @ $T_C = 25^\circ C$ @ $T_C = 100^\circ C$	P_D	375 188	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +175	$^\circ C$
Maximum Lead Temp. for Soldering Purposes (1/8" from Case for 5 s)	T_L	260	$^\circ C$

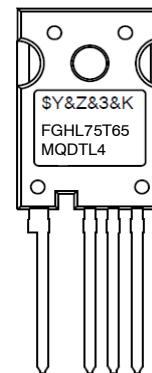
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limit by bond wire
2. $V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A$, Inductive Load, 100% tested
3. Repetitive rating: Pulse width limited by max. junction temperature



TO-247-4LD
CASE 340CJ

MARKING DIAGRAM



&Y = ON Semiconductor Logo
&Z = Assembly Plant Code
&3 = 3-Digit Date Code
&K = 2-Digit Lot Traceability Code
FGHL75T65MQDTL4 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
FGHL75T65MQDTL4	TO-247-4LD	30 Units / Tube

FGHL75T65MQDTL4

Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance Junction-to-case, for IGBT	$R_{\theta JC}$	0.40	$^{\circ}\text{C/W}$
Thermal Resistance Junction-to-case, for Diode	$R_{\theta JC}$	0.60	$^{\circ}\text{C/W}$
Thermal Resistance Junction-to-ambient	$R_{\theta JA}$	40	$^{\circ}\text{C/W}$

Electrical Characteristics ($T_J = 25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited	$V_{GE} = 0\text{ V},$ $I_C = 1\text{ mA}$	BV_{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0\text{ V},$ $I_C = 1\text{ mA}$	$\frac{\Delta BV_{CES}}{\Delta T_J}$	-	0.6	-	$\text{V}/^{\circ}\text{C}$
Collector-emitter Cut-off Current, Gate-emitter Short-circuited	$V_{GE} = 0\text{ V},$ $V_{CE} = 650\text{ V}$	I_{CES}	-	-	250	μA
Gate Leakage Current, Collector-emitter Short-circuited	$V_{GE} = 20\text{ V},$ $V_{CE} = 0\text{ V}$	I_{GES}	-	-	± 400	nA

ON CHARACTERISTICS

Gate-emitter Threshold Voltage	$V_{GE} = V_{CE}, I_C = 75\text{ mA}$	$V_{GE(th)}$	3.0	4.5	6.0	V	
Collector-emitter Saturation Voltage	$V_{GE} = 15\text{ V},$ $I_C = 75\text{ A},$	$T_J = 25^{\circ}\text{C}$	$V_{CE(sat)}$	-	1.45	1.8	V
				$T_J = 175^{\circ}\text{C}$	-	1.65	-

DYNAMIC CHARACTERISTICS

Input Capacitance	$V_{CE} = 30\text{ V},$ $V_{GE} = 0\text{ V},$ $f = 1\text{ MHz}$	C_{ies}	-	4954	-	pF
Output Capacitance		C_{oes}	-	163	-	
Reverse Transfer Capacitance		C_{res}	-	14	-	
Gate Charge Total	$V_{CE} = 400\text{ V},$ $I_C = 75\text{ A},$ $V_{GE} = 15\text{ V}$	Q_g	-	149	-	nC
Gate-to-emitter Charge		Q_{ge}	-	27	-	
Gate-to-collector Charge		Q_{gc}	-	34	-	

SWITCHING CHARACTERISTICS, INDUCTIVE LOAD

Turn-on Delay Time	$T_C = 25^{\circ}\text{C},$ $V_{CC} = 400\text{ V},$ $I_C = 37.5\text{ A},$ $R_G = 10\ \Omega,$ $V_{GE} = 15\text{ V},$ Inductive Load	$t_{d(on)}$	-	30	-	ns	
Rise Time		t_r	-	16	-		
Turn-off Delay Time		$t_{d(off)}$	-	190	-		
Fall Time			t_f	-	35	-	
Turn-on Switching Loss			E_{on}	-	0.6	-	mJ
Turn-off Switching Loss			E_{off}	-	0.5	-	
Total Switching Loss			E_{ts}	-	1.1	-	
Turn-on Delay Time	$T_C = 25^{\circ}\text{C},$ $V_{CC} = 400\text{ V},$ $I_C = 75\text{ A},$ $R_G = 10\ \Omega,$ $V_{GE} = 15\text{ V},$ Inductive Load	$t_{d(on)}$	-	32	-	ns	
Rise Time		t_r	-	29	-		
Turn-off Delay Time		$t_{d(off)}$	-	181	-		
Fall Time			t_f	-	32	-	
Turn-on Switching Loss			E_{on}	-	1.2	-	mJ
Turn-off Switching Loss			E_{off}	-	1.1	-	
Total Switching Loss			E_{ts}	-	2.3	-	

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted) (continued)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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SWITCHING CHARACTERISTICS, INDUCTIVE LOAD

Turn-on Delay Time	$T_C = 150^\circ\text{C}$, $V_{CC} = 400\text{ V}$, $I_C = 37.5\text{ A}$, $R_G = 10\ \Omega$, $V_{GE} = 15\text{ V}$, Inductive Load	$t_{d(on)}$	-	27	-	ns
Rise Time		t_r	-	19	-	
Turn-off Delay Time		$t_{d(off)}$	-	206	-	
Fall Time		t_f	-	44	-	
Turn-on Switching Loss		E_{on}	-	1.9	-	mJ
Turn-off Switching Loss		E_{off}	-	1.8	-	
Total Switching Loss		E_{ts}	-	3.7	-	
Turn-on Delay Time	$T_C = 150^\circ\text{C}$, $V_{CC} = 400\text{ V}$, $I_C = 75\text{ A}$, $R_G = 10\ \Omega$, $V_{GE} = 15\text{ V}$, Inductive Load	$t_{d(on)}$	-	30	-	ns
Rise Time		t_r	-	32	-	
Turn-off Delay Time		$t_{d(off)}$	-	198	-	
Fall Time		t_f	-	40	-	
Turn-on Switching Loss		E_{on}	-	2.0	-	mJ
Turn-off Switching Loss		E_{off}	-	1.4	-	
Total Switching Loss		E_{ts}	-	3.4	-	

DIODE CHARACTERISTICS

Diode Forward Voltage	$I_F = 75\text{ A}$	$T_J = 25^\circ\text{C}$	V_{FM}	-	1.65	2.1	V
		$T_J = 175^\circ\text{C}$		-	1.55	-	

DIODE SWITCHING CHARACTERISTICS, INDUCTIVE LOAD

Reverse Recovery Energy	$T_C = 25^\circ\text{C}$, $V_{CE} = 400\text{ V}$, $I_F = 37.5\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$	E_{REC}	-	105	-	μJ
Diode Reverse Recovery Time		T_{rr}	-	58	-	ns
Diode Reverse Recovery Charge		Q_{rr}	-	591	-	nC
Reverse Recovery Energy	$T_C = 25^\circ\text{C}$, $V_{CE} = 400\text{ V}$, $I_F = 75\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$	E_{REC}	-	235	-	μJ
Diode Reverse Recovery Time		T_{rr}	-	107	-	ns
Diode Reverse Recovery Charge		Q_{rr}	-	1113	-	nC
Reverse Recovery Energy	$T_C = 150^\circ\text{C}$, $V_{CE} = 400\text{ V}$, $I_F = 37.5\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$	E_{REC}	-	747	-	μJ
Diode Reverse Recovery Time		T_{rr}	-	151	-	ns
Diode Reverse Recovery Charge		Q_{rr}	-	2780	-	nC
Reverse Recovery Energy	$T_C = 150^\circ\text{C}$, $V_{CE} = 400\text{ V}$, $I_F = 75\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$	E_{REC}	-	865	-	μJ
Diode Reverse Recovery Time		T_{rr}	-	171	-	ns
Diode Reverse Recovery Charge		Q_{rr}	-	3286	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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TYPICAL CHARACTERISTICS

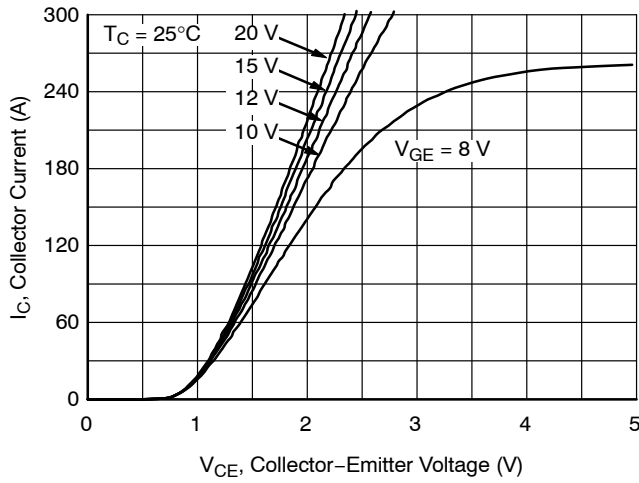


Figure 1. Typical Output Characteristics

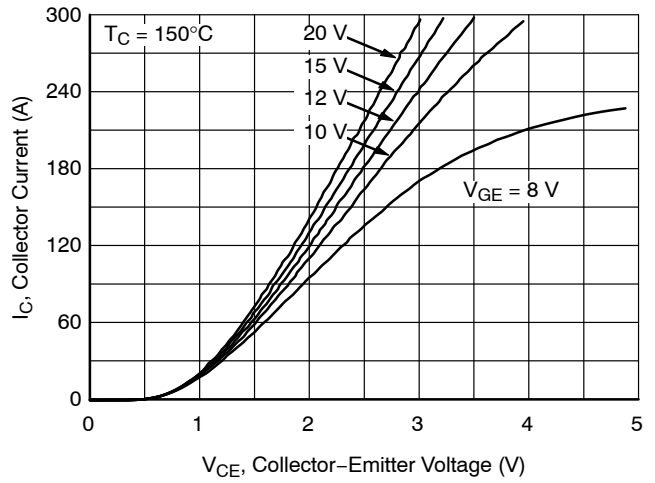


Figure 2. Typical Output Characteristics

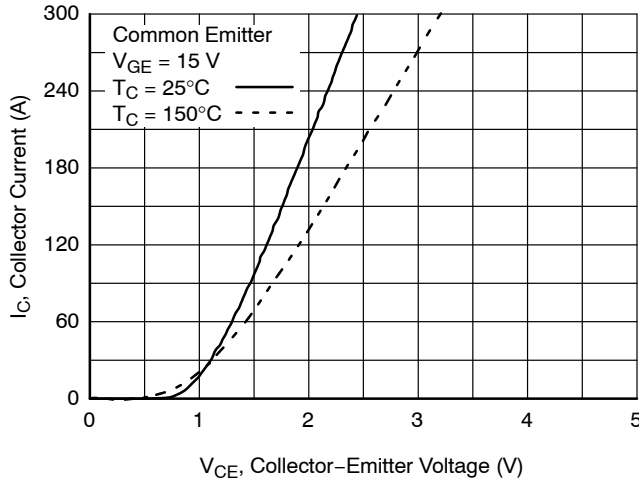


Figure 3. Typical Saturation Voltage

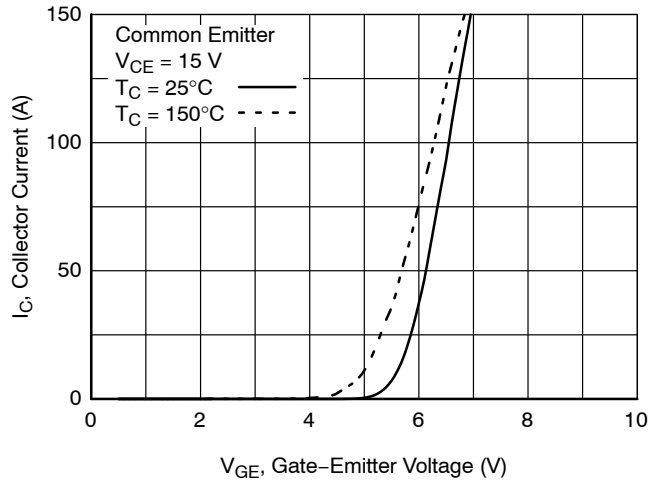


Figure 4. Typical Transfer Characteristics

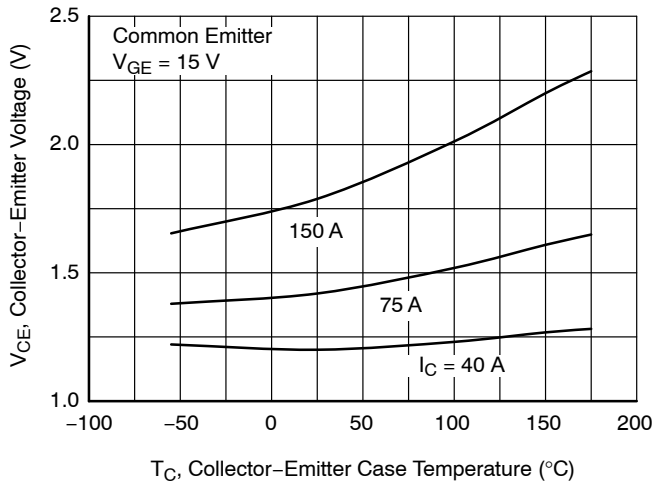


Figure 5. Saturation Voltage vs. Case Temperature

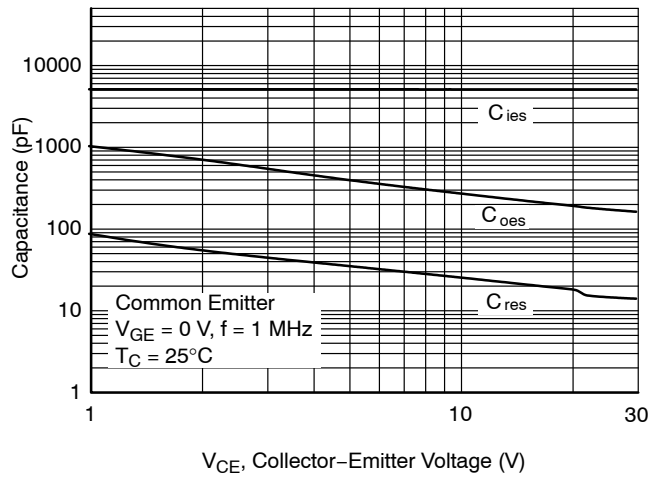


Figure 6. Capacitance Characteristics

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TYPICAL CHARACTERISTICS (continued)

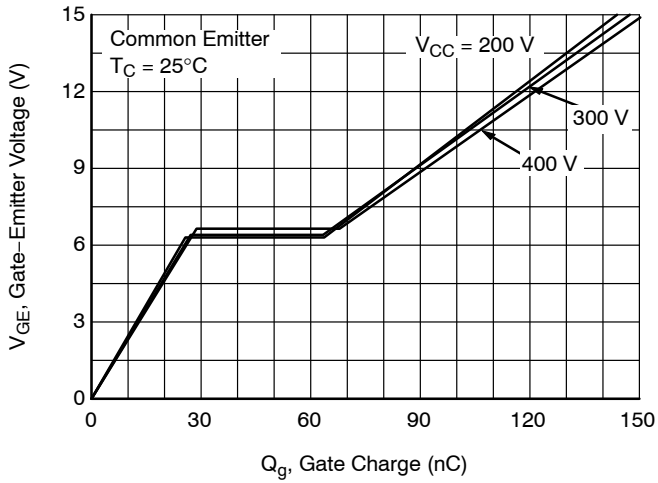


Figure 7. Gate Charge Characteristics

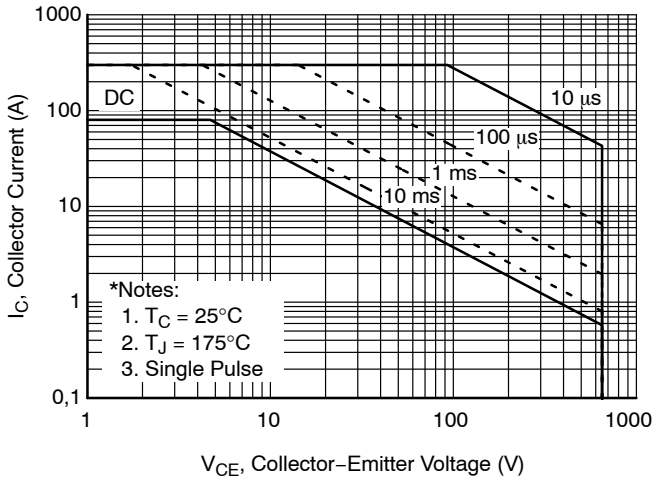


Figure 8. SOA Characteristics

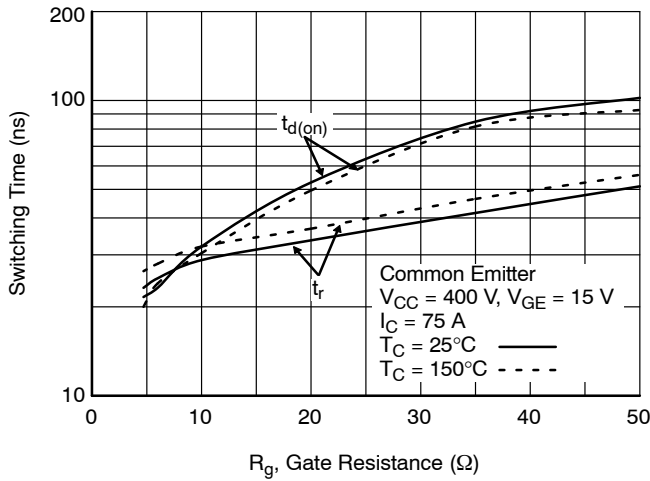


Figure 9. Turn-On Characteristics vs. Gate Resistance

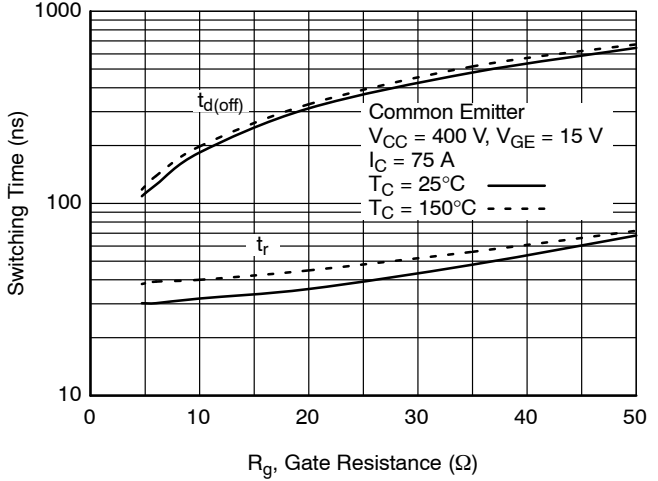


Figure 10. Turn-Off Characteristics vs. Gate Resistance

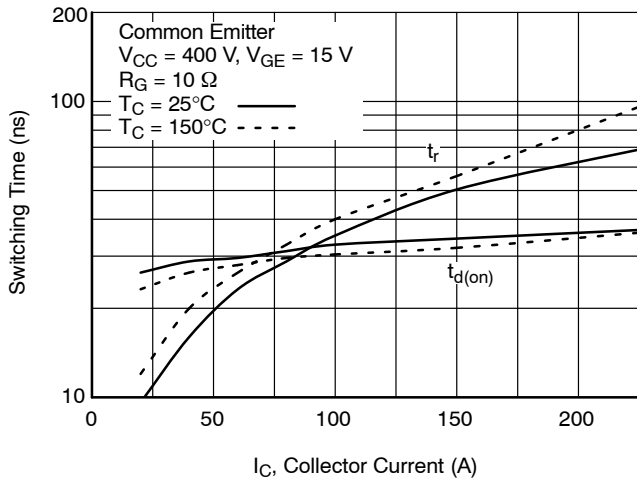


Figure 11. Turn-On Characteristics vs. Collector Current

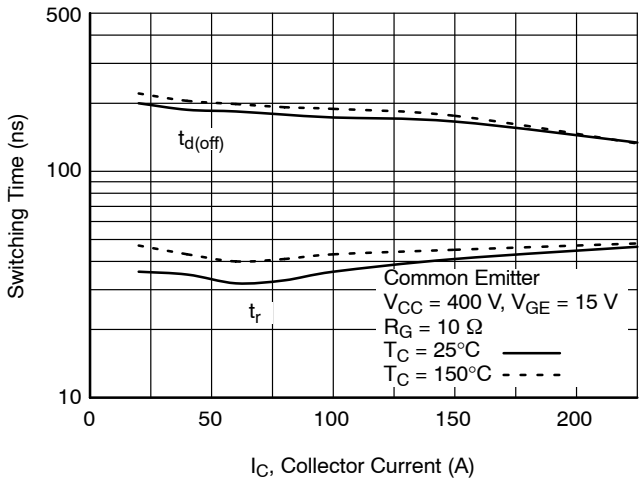


Figure 12. Turn-Off Characteristics vs. Collector Current

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TYPICAL CHARACTERISTICS (continued)

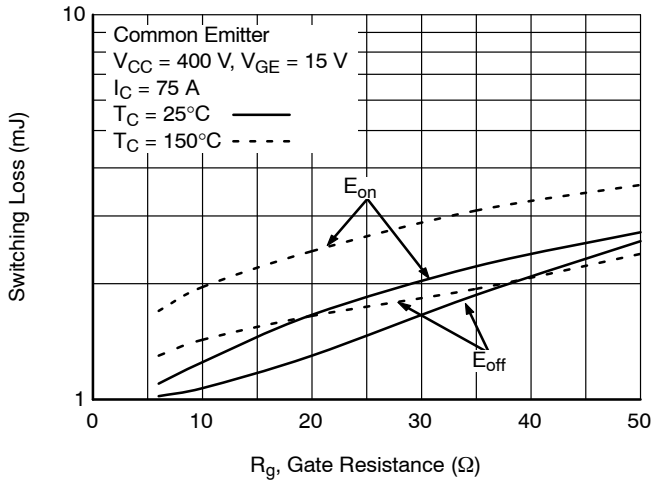


Figure 13. Switching Loss vs. Gate Resistance

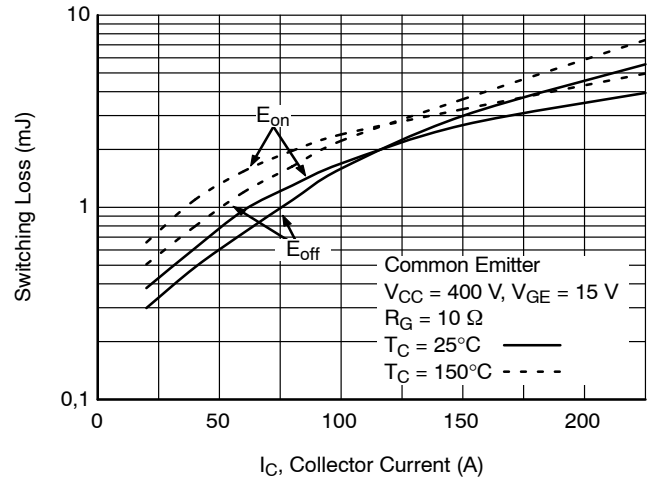


Figure 14. Switching Loss vs. Collector Current

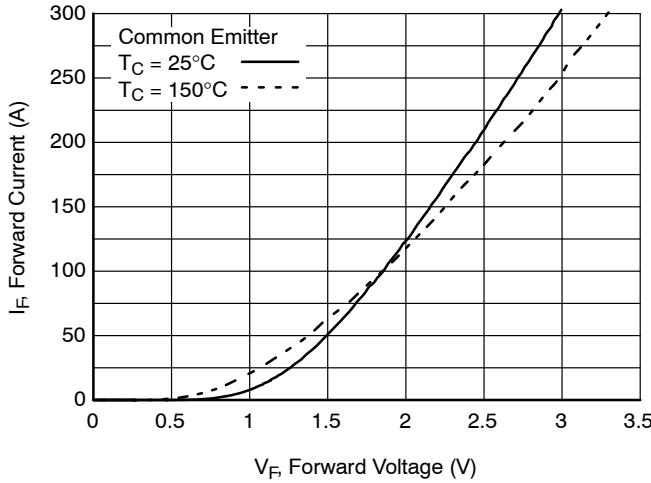


Figure 15. Forward Characteristics

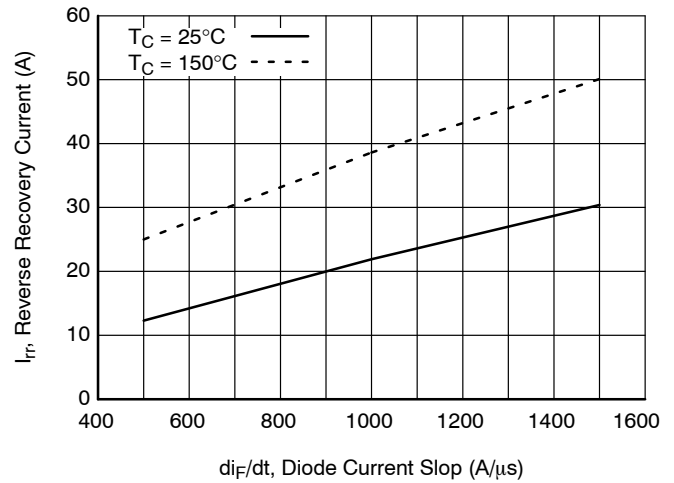


Figure 16. Reverse Recovery Current

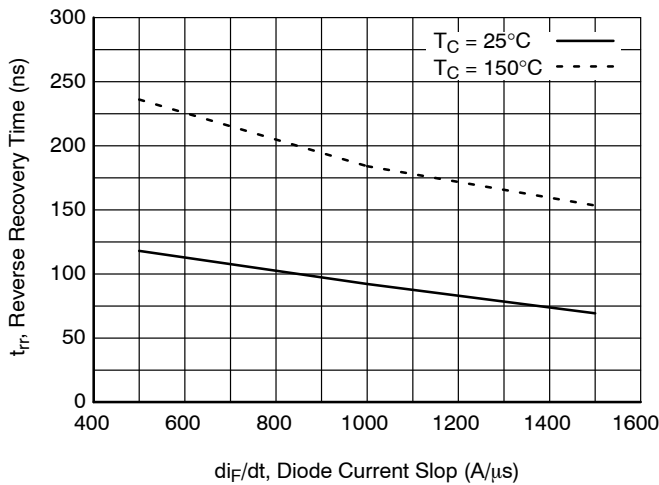


Figure 17. Reverse Recovery Time

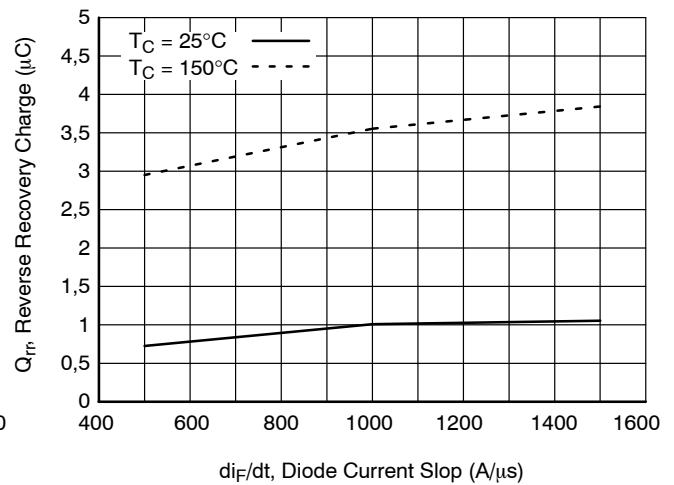


Figure 18. Stored Charge

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TYPICAL CHARACTERISTICS (continued)

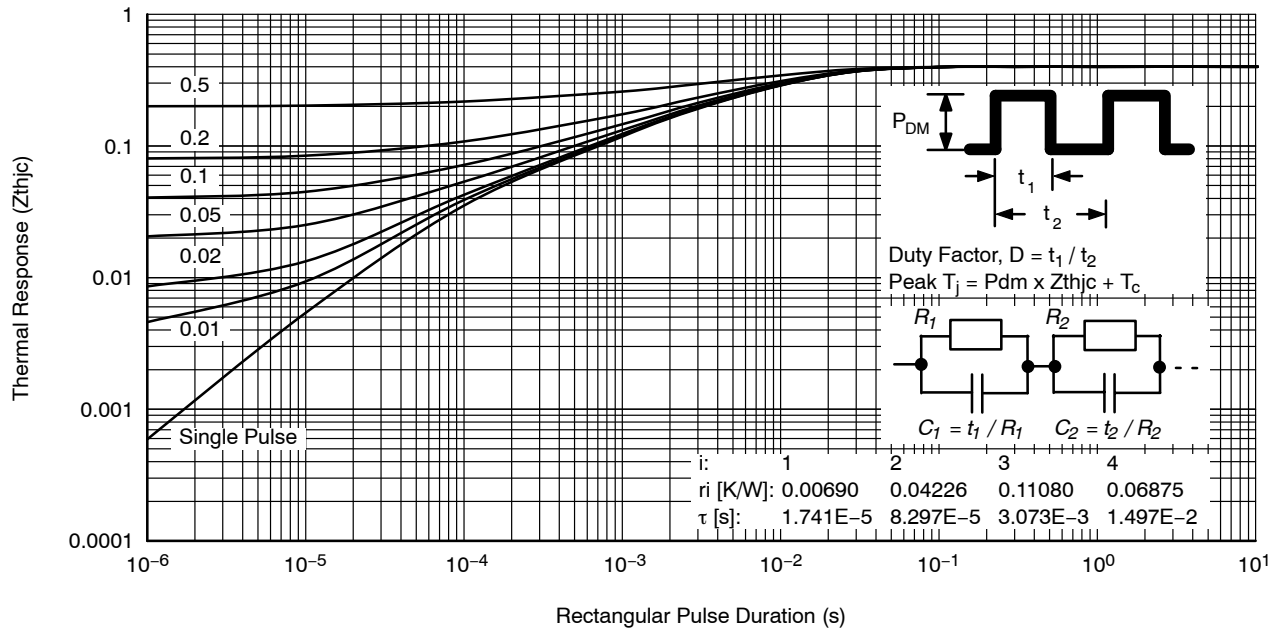


Figure 19. Transient Thermal Impedance of IGBT

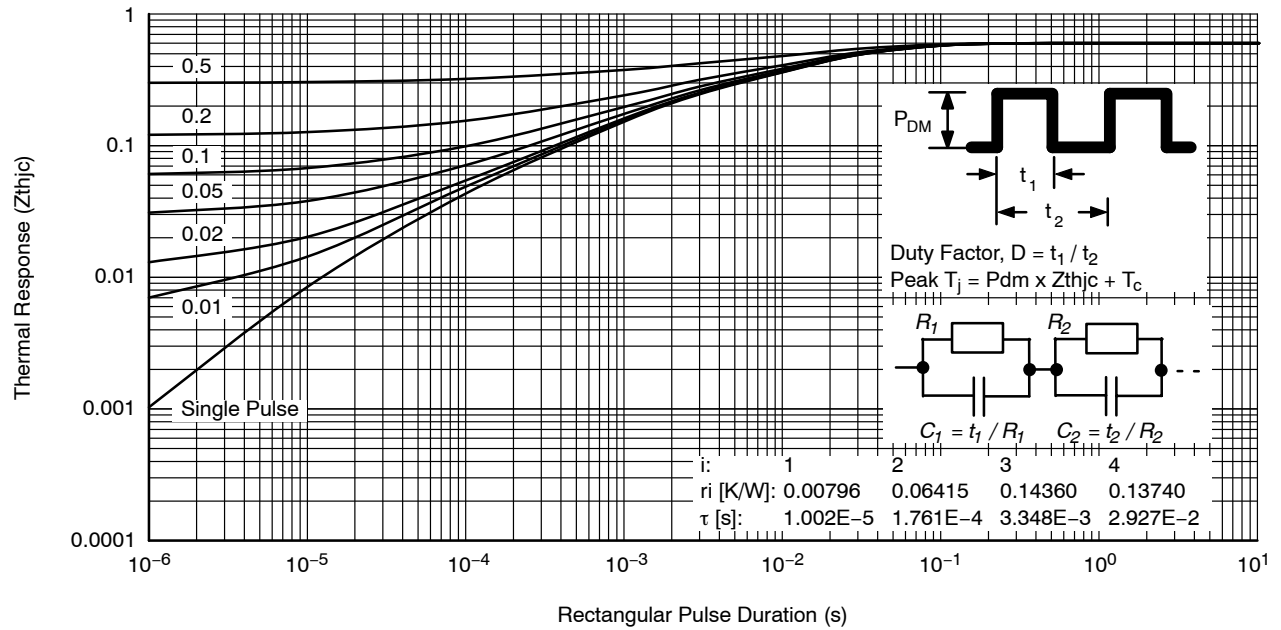
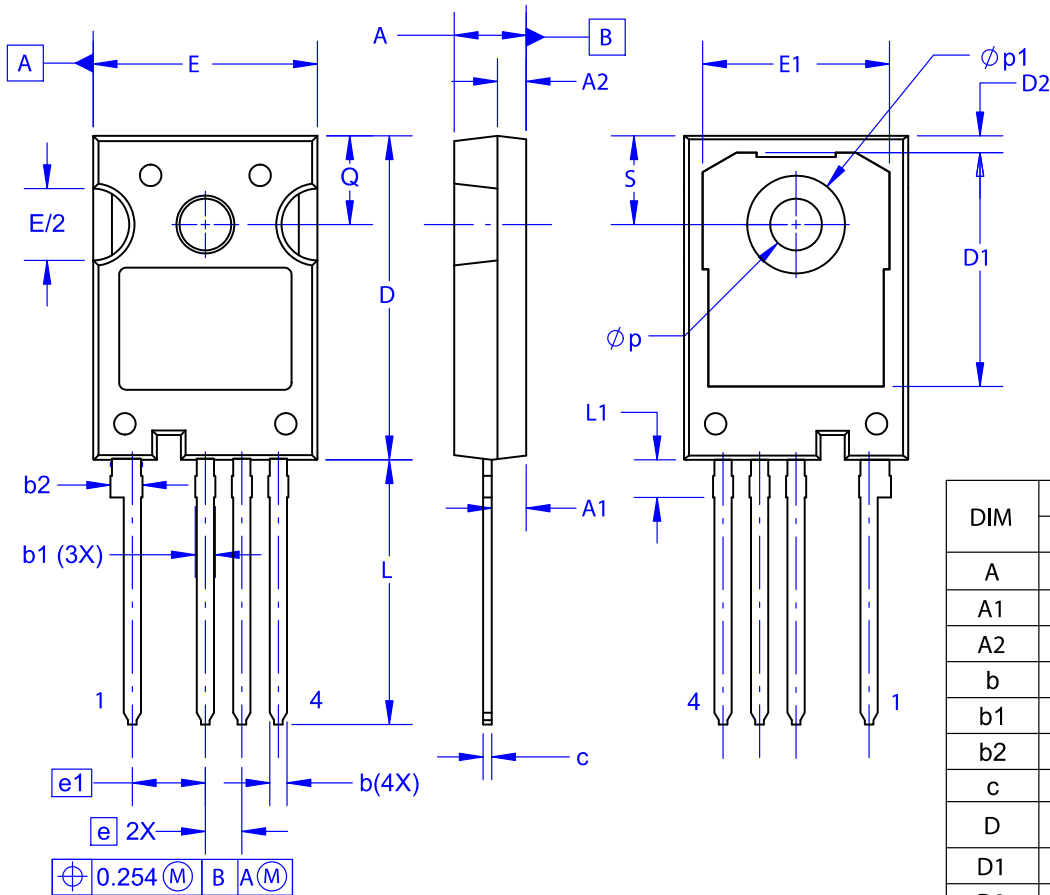


Figure 20. Transient Thermal Impedance of Diode

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PACKAGE DIMENSIONS

TO-247-4LD
CASE 340CJ
ISSUE A



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
e	2.54 BSC		
e1	5.08 BSC		
E	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
p	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

NOTES:

- A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- C. ALL DIMENSIONS ARE IN MILLIMETERS.
- D. DRAWING CONFORMS TO ASME Y14.5-2009.

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